

Film Capacitors

EMI Suppression Capacitors (MKP)

 Series/Type:
 B32922H/J ... B32926H/J

 Date:
 July 2016

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EMI suppression capacitors (MKP)

X2 / 305 V AC

B32922H/J ... B32926H/J

Typical applications

- X2 class for interference suppression
- "Across the line" applications
- Severe ambient conditions
- For connections in series with the mains
- Capacitive power supply
- Energy meters

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1): 40/110/56

Construction

- Dielectric: metallised polypropylene (MKP)
- Wound film technology
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Self-healing properties
- High stability of capacitance value

Terminals

- Parallel wire leads
- Lead-free tinned
- Standard lead lengths: 6-1 mm
- Special lead lengths available on request

Marking

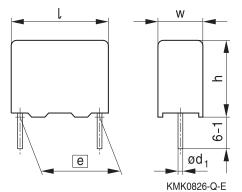
Manufacturer's logo, lot number, date code, rated capacitance (coded), cap. tolerance (code letter), rated AC voltage, series number, sub-class (X2), dielectric code (MKP), climatic category, passive flammability category, approvals

Delivery mode

Bulk (untaped) Taped (Ammo pack or reel) For taping details, refer to chapter "Taping and packing"

Dimensional drawings

Drawing A1



Dimensions in mm

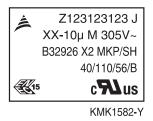
Number of wires	Lead spacing <i>e</i> _±0.4	Lead diameter d1 ±0.05	Туре
2-pin	15.0	0.8	B32922 H/J
2-pin	22.5	0.8	B32923 H/J
2-pin	27.5	0.8	B32924 H/J
2-pin	37.5	1.0	B32926 H/J





B32922H/J ... B32926H/J X2 / 305 V AC

Marking Examples



Approvals

Approval marks	Standards	Certificate
31 5	EN 60384-14, IEC 60384-14, Ed. 3	ENEC-00812 (approved by UL)
c Al us	UL 60384-14, CSA E60384-14	E97863 (approved by UL)





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Overview of available types

Lead spacing	15 mm	22.5 mm	27.5 mm	37.5 mm
Туре	B32922 H/J	B32923 H/J	B32924 H/J	B32926 H/J
Γyρο C _R (μF)		00202011/0		00202011/0
0.10				
0.15				
0.2				
0.22				
0.33				
0.410				
0.47				
0.56				
0.68				
0.82				
1.0				
1.5				
2.2				
3.3				
4.7				
6.8				
8.2				
10				
15				



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Ordering codes and packing units

Lead	C _R	Max. dimensions	Ordering code	Straight	Straight	Straight
spacing		$w \times h \times l$	(composition see	terminals,	terminals,	terminals,
mm	μF	mm	below)	Ammo	Reel	Untaped
				pack		
				pcs./MOQ	pcs./MOQ	pcs./MOQ
15	0.10	$6.0\times11.0\times18.0$	B32922H3104+***	3840	4400	4000
	0.15	$7.0\times12.5\times18.0$	B32922H3154+***	3320	3600	4000
	0.20	$8.0\times14.0\times18.0$	B32922H3204+***	2920	3000	2000
	0.22	$8.0\times14.0\times18.0$	B32922H3224M***	2920	3000	2000
	0.22	$8.5\times14.5\times18.0$	B32922J3224+***	2720	2800	2000
	0.33	$9.0\times17.5\times18.0$	B32922H3334+***	2560	2800	2000
	0.47	$11.0\times18.5\times18.0$	B32922H3474+***	_	2200	1200
22.5	0.22	$7.0\times16.0\times26.5$	B32923H3224+***	2320	2400	2520
	0.33	$8.5\times16.5\times26.5$	B32923J3334+***	1920	2000	2040
	0.41	$8.5\times16.5\times26.5$	B32923H3414M***	1920	2000	2040
	0.47	$10.5\times16.5\times26.5$	B32923H3474+***	1560	1600	2160
	0.56	$10.5\times18.5\times26.5$	B32923H3564+***	1560	1600	2160
	0.68	$10.5\times18.5\times26.5$	B32923H3684M***	1560	1600	2160
	0.68	$11.0\times20.5\times26.5$	B32923J3684+***	—	—	2040
	0.82	$11.0\times20.5\times26.5$	B32923H3824+***	—	—	2040
	1.0	$12.0\times22.0\times26.5$	B32923H3105+***	-	—	1800
	1.5	$14.5\times29.5\times26.5$	B32923H3155+***	-	—	1040
	2.2	$14.5\times29.5\times26.5$	B32923H3225M***	_	_	1040

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

- + = Capacitance tolerance code:
 - $M = \pm 20\%$
 - K = ±10%

- *** = Packaging code:
 - 289 = Straight terminals, Ammo pack for lead spacing 15 mm and 22.5 mm
 - 189 = Straight terminals, Reel
 - 255 = Crimped down from lead spacing 15 mm to 7.5 mm, Ammo pack
 - 155 = Crimped down from lead spacing 15 mm to 7.5 mm, Reel
 - 003 = Straight terminals, untaped (lead length $3.2 \pm 0.3 \text{ mm}$)
 - 000 = Straight terminals, untaped (lead length 6 1 mm)





X2 / 305 V AC

Ordering codes and packing units

Lead	C _R	Max. dimensions	Ordering code	Straight	Straight	Straight
spacing		$w \times h \times l$	(composition see	terminals,	terminals,	terminals,
mm	μF	mm	below)	Ammo	Reel	Untaped
				pack		-
				pcs./MOQ	pcs./MOQ	pcs./MOQ
27.5	0.68	$11.0 \times 19.0 \times 31.5$	B32924H3684+***	_	1400	1280
	1.0	$11.0 \times 21.0 \times 31.5$	B32924H3105+***	_	1400	1280
	1.5	$13.5\times23.0\times31.5$	B32924H3155M***	_	1000	1040
	1.5	$14.0\times24.5\times31.5$	B32924J3155+***	—	_	1040
	2.2	$16.0\times32.0\times31.5$	B32924J3225+***	—	_	880
	2.2	$18.0\times27.5\times31.5$	B32924H3225+***	—	_	800
	3.3	$18.0\times33.0\times31.5$	B32924J3335+***	—	_	800
	3.3	$19.0\times30.0\times31.5$	B32924H3335M***	—	_	720
	4.7	$22.0\times36.5\times31.5$	B32924H3475+***	—	—	640
37.5	2.2	$14.0\times25.0\times42.0$	B32926H3225+***	—	—	1380
	3.3	$16.0\times28.5\times42.0$	B32926H3335+***	—	—	800
	4.7	$18.0\times32.5\times42.0$	B32926H3475+***	—	—	720
	6.8	$20.0\times39.5\times42.0$	B32926H3685+***	—	—	640
	8.2	$28.0\times37.0\times42.0$	B32926J3825+***	—	—	440
	10.0	$28.0\times37.0\times42.0$	B32926H3106M***	-	—	440
	10.0	$28.0\times42.5\times42.0$	B32926J3106+***	-	_	440
	15.0	$33.0\times48.0\times42.0$	B32926H3156+***	-	-	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

- + = Capacitance tolerance code:
 - $M = \pm 20\%$
 - $K = \pm 10\%$

- *** = Packaging code:
 - 289 = Straight terminals, Ammo pack for lead spacing 15 mm and 22.5 mm
 - 189 = Straight terminals, Reel
 - 255 = Crimped down from lead spacing 15 mm to 7.5 mm, Ammo pack
 - 155 = Crimped down from lead spacing 15 mm to 7.5 mm, Reel
 - 003 = Straight terminals, untaped (lead length 3.2 ±0.3 mm)
 - 000 = Straight terminals, untaped (lead length 6 1 mm)



X2 / 305 V AC

X2

Technical data and specifications

Reference standard: IEC / UL 60384-14. All data given at T = 20 $^{\circ}$ C unless otherwise specified.

Rated AC voltage (IEC 60384-14)	305 V AC (50/60 Hz)					
Maximum continuous DC voltage V _{DC}	630 V DC					
DC voltage test	Between term	inals: 131	12 V DC / 2	S		
The repetition of this DC voltage test i	nay damage th	e capacit	or. Special	care mi	ust b	oe taken
incase of use several capacitors in a p	parallel configu	ration.				
Max. operating temperature $T_{op,max}$	+110 °C					
Dissipation factor tan δ (in 10 ⁻³)		C _R ≤0.1 μ	ιF 0.1μF<0	C _R ≤2.2	μF	C _R >2.2 μF
at 20 $^\circ\text{C}$ (upper limit values)	at 1 kHz	1.0	1.0			2.0
	100 kHz	5.0	-			_
Insulation resistance R_{ins} (in $G\Omega$)	$C_{\text{R}} \le 0.33 \ \mu\text{F}$			$C_R > 0$.33 µ	ιF
or time constant $\tau = C_R \cdot R_{ins}$ (in s)	100 GΩ			30 000)s	
at 20 °C, rel. humidity \leq 65%						
(minimum as-delivered values)						
Operating AC voltage V_{op} at high	$T_{op} \le 110 \ ^{\circ}C$		$V_{op} = V_{AC}$	(cont	tinuously)
temperature	$T_{op} \le 110 \ ^{\circ}C$		$V_{op} = 1.25$	$\cdot V_{AC}$ ((100	0 h)
Passive flammability category	В					
Damp heat test	Test 1:	Tempera	ature:	8	35 °C	C±2 °C
		Relative humidity (RH):			85%±2%	
		Test duration:		1	1000 h	
		Voltage value:		2	240 V AC, 50 Hz	
	Test 2:	Temperature:			50 °C	C±2 °C
		Relative	humidity (F	(RH): 95%±2%		<u>+</u> 2%
		Test dura	ation:	, 1000 h) h
		Voltage value:			240 V AC, 50 Hz	
Limit values after damp heat test	Capacitance of	change (Δ		%		
	Dissipation fa	ctor chan	ge (Λtan δ):	:<5 · 1	0 ⁻³ ((at 1 kHz)
	for lead spaci				• (()
	Dissipation factor change ($\Delta \tan \delta$): $\leq 2 \cdot 10^{-2}$ (at 1 kHz)					
	for lead spaci				0 ((at 1 11 12)
		U				
	Δ tan δ/tan δ ≤ 2000% (at 10 kHz) Insulation resistance R _{ins} : ≥ 200 MΩ					
Reference standard	AEC-Q200	ISIANCE N	ins. ∠ 200 IVI	22		





Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/µs.

Note:

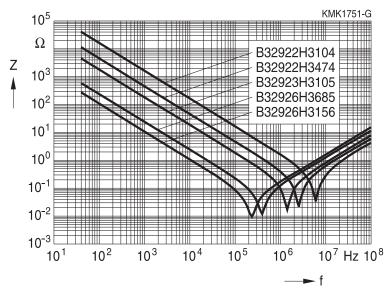
The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and k₀ values

Lead spacing	15 mm	22.5 mm	27.5 mm	37.5 mm
dV/dt in V/µs	340	170	120	80
k₀ in V²/μs	292400	146200	103200	68800

Impedance Z versus frequency f

(typical values)



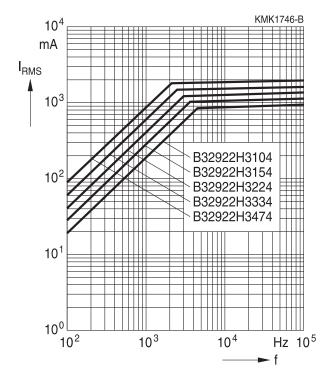


B32922H/J ... B32926H/J X2 / 305 V AC

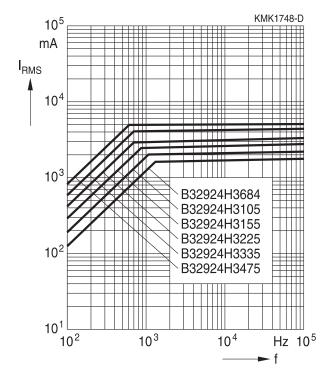
X2

Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveform, TA \leq 90 °C and $\Delta ESR <$ 100% from receipt condition)

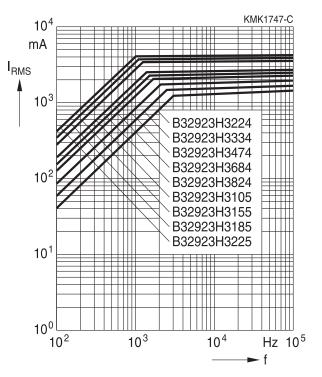
Lead spacing 15 mm



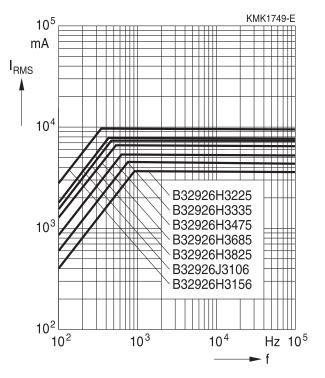
Lead spacing 27.5 mm



Lead Spacing 22.5 mm











X2 / 305 V AC

Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical	IEC 60384-14	Voltage Proof:		Within specified limits
Parameters		Between terminals:		
		$4.3 \times V_{R}$ (DC), 2s		
		Terminals and encl	osure:	
		2 V _R + 1500 V AC		
		Insulation resistanc	e, R _{INS}	
		Capacitance, C		
		Dissipation factor, t	an δ	
Robustness	IEC 60068-2-21	Tensile strength (te	st Ua1)	Capacitance and tan δ
of termina-			Tensile	within specified limits
tions		Wire diameter	force	
		$0.5 < d_1 \le 0.8 \text{ mm}$	10 N	-
		$0.8 < d_1 \le 1.25 \text{ mm}$	-	
Resistance to	IEC 60068-2-20,	Solder bath temper		$\Delta C/C_0 \leq 5\%$
soldering	test Tb,	260 ± 5 °C, immers		tan δ within specified limits
heat	method 1A	10 seconds		tan o within specified limits
				No visible demage
Rapid	IEC 60384-14	$T_A = lower category$	•	No visible damage
change of		$T_{\rm B}$ = upper category	•	$ \Delta C/C_0 \le 5\%$
temperature		Five cycles, duratio	n t = 30 min.	tan δ within specified limits
Vibration	IEC 60384-14	Test F _c : vibration si	nusoidal	No visible damage
		Displacement: 0.75	mm	
		Accleration: 98 m/s	2	
		Frequency: 10 Hz .		
		Test duration: 3 ort	nogonal axes,	
		2 hours each axe		
Bump	IEC 60384-14	Test Eb: Total 4000 bumps with		No visible damage
		400 m/s ² mounted of	on PCB	$ \Delta C/C_0 \le 5\%$
		6 ms duration		tan δ within specified limits
Damp Heat	IEC 60384-14	Test Ca		No visible damage
Steady State		40 °C / 93% RH / 5	6 days	$ \Delta C/C_0 \le 5\%$
-				$I\Delta \tan \delta I \le 0.008$ for $C \le 1 \ \mu F$
				$I\Delta \tan \delta I < 0.005$ for C > 1 μ F
				Voltage proof
				$R_{INS} \ge 50\%$ of initial limit
Impulse test	IEC 60384-14	3 impulses		No visible damage
Endurance		T _B / 1.25 V _R / 1000	hours,	$ \Delta C/C_0 \le 10\%$
		1000 V_{rms} for 0.1 s every hour		$I\Delta$ tan $\delta I \leq 0.008$ for $C \leq 1~\mu F$
				$I\Delta$ tan $\delta I < 0.005$ for C > 1 μF
				Voltage proof
				$R_{INS} \ge 50\%$ of initial limit





Test	Reference	Conditions of test	Performance requirements
Passive flammability	IEC 60384-14	Flame applied for a period of time depending on capacitor volume	В
Active flammability	IEC 60384-14	20 discharges at 2.5 kV + V_R	The cheesecloth shall not burn with a flame

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

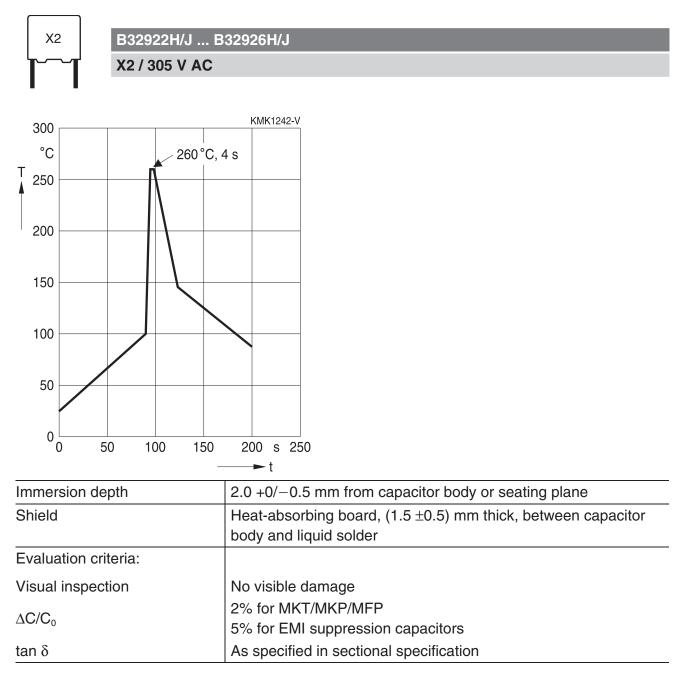
Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/ -0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder \geq 90%, free-flowing solder

1.2 **Resistance to soldering heat**

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Series	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP		-	
MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case 2.5 \times 6.5 \times 7.2 mm)		5 ±1 s
MKP	(lead spacing \leq 7.5 mm)		< 4 s
MKT	uncoated (lead spacing \leq 10 mm)		recommended soldering
	insulated (B32559)		profile for MKT uncoated
			(lead spacing \leq 10 mm) and
			insulated (B32559)







X2 / 305 V AC

X2

1.3 General notes on soldering

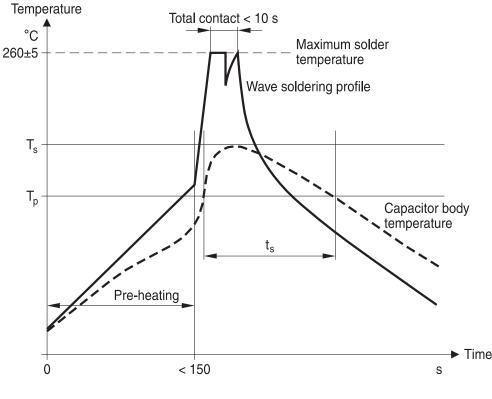
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:

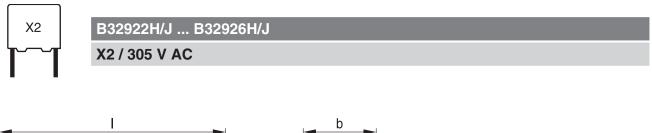


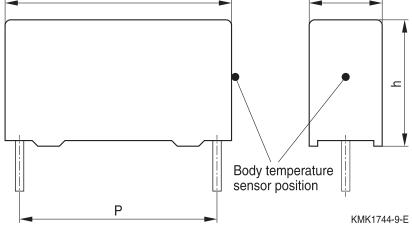
Ts: Capacitor body maximum temperature at wave soldering

T_p: Capacitor body maximum temperature at pre-heating

KMK1745-A-E







Body temperature should follow the description below:

- MKP capacitor During pre-heating: T_p ≤ 110 °C During soldering: T_s ≤ 120 °C, t_s ≤ 45 s
- MKT capacitor
 During pre-heating: $T_p \le 125 \text{ °C}$ During soldering: $T_s \le 160 \text{ °C}$, $t_s \le 45 \text{ s}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

For manual soldering or selective soldering, body temperature $T_s \leq 120$ °C is also required to qualify soldering condition. One recommended condition for manual soldering is that soldering iron tip temperature below 360 °C, and soldering contact time not more than 3 seconds.

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.



X2 / 305 V AC

X2

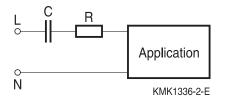
Application note for the different possible X1 / X2 positions

In series with the powerline (i.e. capacitive power supply)

Typical Applications:

- Power meters
- ECUs for white goods and household appliances
- Different sensor applications
- Severe ambient conditions

Basic circuit



Required features

- High capacitance stability over the lifetime
- Narrow tolerances for a controlled current supply

Recommended EPCOS product series

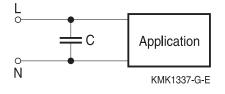
- B3293* (305 V AC) heavy duty with EN approval for X2 (UL Q1/2010)
- B3265* MKP series standard MKP capacitor without safety approvals
- B3267*L MKP series standard MKP capacitor without safety approvals
- B3292*H/J (305 V AC), severe ambient condition, approved as X2

In parallel with the powerline

Typical Applications:

Standard X2 are used parallel over the mains for reducing electromagnetic interferences coming from the grid. For such purposes they must meet the applicable EMC directives and standards.

Basic circuit



Required features

- Standard safety approvals (ENEC, UL, CSA, CQC)
- High pulse load capability
- Withstand surge voltages

Recommended EPCOS product series

- B3292*C/D (305 V AC) standard series, approved as X2
- B3291* (330 V AC), approved as X1
- B3291* (530 V AC), approved as X1
- B3292*H/J (305 V AC), severe ambient condition, approved as X2





X2 / 305 V AC

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



X2 / 305 V AC

X2

Торіс	Safety information	Reference chapter "General technical
		information"
Topic	Safety information	Reference chapter
		"Mounting guidelines"
Soldering	Do not exceed the specified time or temperature	1 "Soldering"
	limits during soldering.	
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of	When embedding finished circuit assemblies in	3 "Embedding of
capacitors in	plastic resins, chemical and thermal influences	capacitors in finished
finished assemblies	must be taken into account.	assemblies"
	Caution: Consult us first, if you also wish to	
	embed other uncoated component types!	

Design of EMI Capacitors

EPCOS EMI capacitors use polypropylene (PP) film metalized with a thin layer of Zinc (Zn). The following key points have made this design suitable to IEC/UL testing, holding a minimum size.

- Overvoltage AC capability with very high temperature Endurance test of IEC60384-14 (3rd edition, 2005-07) / UL60384-14 (1st edition, 2009-04) must be performed at 1.25 × V_R at maximum temperature, during 1000 hours, with a capacitance drift less than 10%.
- Higher breakdown voltage withstanding if compared to other film metallizations, like Aluminum. IEC60384-14 (3rd edition, 2005-07) / UL60384-14 (1st edition, 2009-04) establishes high voltage tests performed at $4.3 \times V_{\rm R} 1$ minute, impulse testing at 2500 V for C= 1 µF and active flammability tests.
- Damp heat steady state: 40 °C/ 93% RH / 56 days. (without voltage or current load)

Effect of humidity on capacitance stability

Long contact of a film capacitor with humidity can produce irreversible effects. Direct contact with liquid water or excess exposure to high ambient humidity or dew will eventually remove the film metallization and thus destroy the capacitor. Plastic boxed capacitors must be properly tested in the final application at the worst expected conditions of temperature and humidity in order to check if any parameter drift may provoke a circuit malfunction.

In case of penetration of humidity through the film, the layer of Zinc can be degraded, specially under AC operation (change of polarity), accelerated by the temperature, provoking an increment of the serial resistance of the electrode and eventually a reduction of the capacitance value. For DC operation, the parameter drift is much less.

Plastic boxes and resins can not protect 100% against humidity. Metal enclosures, resin potting or coatings or similar measures by customers in their applications will offer additional protection against humidity penetration.





Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under <u>www.epcos.com/orderingcodes</u>.



X2

B32922H/J ... B32926H/J

X2 / 305 V AC

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α _c	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β _c	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
∆C/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f ₂	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F⊤	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





X2/305 V AC

Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i _z	Capacitance drift	Inkonstanz der Kapazität
ν _z k ₀	Pulse characteristic	Impulskennwert
L _S	Series inductance	Serieninduktivität
Ls λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
<i>N</i> ₀	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P _{diss}	Dissipated power	Abgegebene Verlustleistung
P _{gen}	Generated power	Erzeugte Verlustleistung
Q gen	Heat energy	Wärmeenergie
	Density of water vapor in air	Dichte von Wasserdampf in Luft
ρ R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
	On the resistance of discharge circuit	Entladekreises
R _i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
R _s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$\tan \delta_{\rm D}$	Dielectric component of dissipation	Dielektrischer Anteil des Verlustfaktors
	factor	
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_s	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T _{op}	Operating temperature	Beriebstemperatur
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer



X2

X2 / 305 V AC

Symbol	English	German
V _{AC}	AC voltage	Wechselspannung
V _c	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V _{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V _R	Rated voltage	Nennspannung
ν̂ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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